## AMPMODU | AMPMODU Headers

TE Internal #: 87527-3

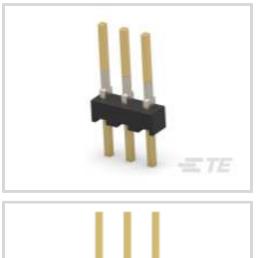
PCB Mount Header, Vertical, Board-to-Board, 3 Position, 2.54 mm [. 1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal,

AMPMODU Headers

View on TE.com >

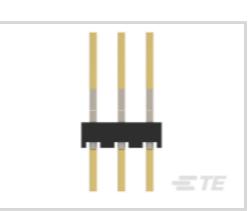


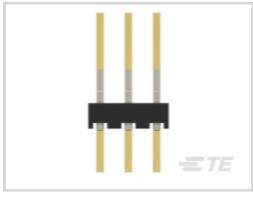
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 3
Number of Rows: 1

#### **Features**

## **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	3
Number of Rows	1
Board-to-Board Configuration	Parallel

#### **Electrical Characteristics**

Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 Vrms



# **Body Features**

Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.91 mm[.154 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Nylon-GF
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal



#### **Industry Standards**

UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500
Packaging Type	Carton

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts





# Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Headers & Receptacles(4875)



PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(65)

# Customers Also Bought



TE Part #2-2330552-2
ICX POINT PHM CARRIER ASSY, P4

TE Part #2309848-2 PCI-E Card Edge, 64 Pos, 15u", TE Part #2333799-8 RCPT ASSY, VERT, 168 POS, SLIVER 2.0



TE Part #3-2360229-6 Low Profile Slimline SAS 16X V/T REC

TE Part #1-2325185-7
CAGE ASSY W/ RIGHT 2LP 1X2 QSFP-DD

TE Part #1-2328461-2 280 POS., CONNECTOR ASSEMBLY, SLIVER 2.0 TE Part #2355926-1 C/A 8x10 HDR to HDR Jumper TE Part #2375584-4 sliver 168P INTERPOSER TO SLIVER 4C+



TE Part #3-1775099-9

ATX PWR CONN 1 BDLK 24 POS

#### **Documents**

## **Product Drawings**

03 MODII HDR SRST UNSHRD .100

English

**CAD Files** 

3D PDF

English

**Customer View Model** 

ENG\_CVM\_87527-3\_G.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_87527-3\_G.3d\_stp.zip

English

**Customer View Model** 

ENG\_CVM\_87527-3\_G.2d\_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

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